

Pb RoHS

#### **General Description**

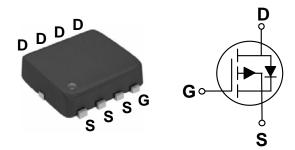
These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	Ι <sub>D</sub>
-30 V	11 mΩ	-35 A

#### Features

- -30V, -35A, R<sub>DS(ON)</sub>=11m Ω @V<sub>GS</sub>= -10V
- Fast switching
- Suit for -4.5V Gate Drive Applications

#### PPAK3X3 Pin Configuration



#### **Applications**

- MB / VGA / V<sub>CORE</sub>
- POL Applications
- LED Application
- Load Switch

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	-30	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub>	Drain Current - Continuous (T <sub>c</sub> =25°C)	-35	Α
١D	Drain Current - Continuous (T <sub>c</sub> =100°C)	-22.1	А
I <sub>DM</sub>	Drain Current - Pulsed (NOTE 1)	-140	А
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> =25°C)	23	W
I D	Power Dissipation - Derate above 25°C	0.18	W/°C
TJ	Operating Junction Temperature Range	-50 to 150	°C
T <sub>STG</sub>	Storage Temperature Range	-50 to 150	°C
Marking Code		PC011	

Thermal Characteristics							
Symbol	Parameter	Тур.	Max	Unit			
$R_{ extsf{ heta}JA}$	Thermal Resistance Junction to Ambient		62	°C/W			
$R_{ extsf{ heta}JC}$	Thermal Resistance Junction to Case		5.4	°C/W			





#### Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V , I <sub>D</sub> = -250uA	-30			V
1	Ines IDrain-Source Leakage Current	$V_{DS}$ = -30V , $V_{GS}$ = 0V , $T_{J}$ =25°C			-1	uA
DSS		$V_{DS}$ = -24V , $V_{GS}$ = 0V , $T_J$ =125°C			-10	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ = ±20V , $V_{DS}$ = 0V			±100	nA

#### **On Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = -10V , I <sub>D</sub> = -8A		9	11	mΩ
		V <sub>GS</sub> = -4.5V , I <sub>D</sub> = -6A		12	15	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_{D}=-250$ uA	-1.2	-1.6	-2.5	V
gfs	Forward Transconductance	V <sub>DS</sub> = -10V , I <sub>D</sub> = -8A		10.5		S

#### **Dynamic and switching Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Qg	Total Gate Charge (NOTE 2  3)	$\lambda = 45\lambda + \lambda = 45\lambda$		14.6	21	
$Q_gs$	Gate-Source Charge (NOTE 2 \ 3)	−V <sub>DS</sub> = -15V , V <sub>GS</sub> = -4.5V , _I <sub>D</sub> = -8A		4.1	6	nC
$Q_gd$	Gate-Drain Charge (NOTE 2 \ 3)	10- 0, (		6.3	9	
T <sub>d(on)</sub>	Turn-On Delay Time (NOTE 2 \ 3)			9	17	
Tr	Rise Time (NOTE 2 \ 3)	V <sub>DS</sub> = -15V , V <sub>GEN</sub> = -10V ,		21.8	41	nS
T <sub>d(off)</sub>	Turn-Off Delay Time (NOTE 2 、3)	$R_{GS}$ = 6 $\Omega$ , $I_{D}$ = -1A		59.8	114	115
T <sub>f</sub>	Fall Time (NOTE 2 \ 3)			14.4	27	
C <sub>iss</sub>	Input Capacitance			1730	2510	
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ = -15V , $V_{GS}$ = 0V , F= 1MHz		180	260	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			125	180	

#### **Drain-Source Diode Characteristics and Ratings**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I <sub>S</sub>	Continuous Source Current	$V_{G} = V_{D} = 0V$ , Force Current			-30	Α
I <sub>SM</sub>	Pulsed Source Current				-120	Α
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> = 0V , I <sub>S</sub> = -1A			-1	V

NOTES :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.

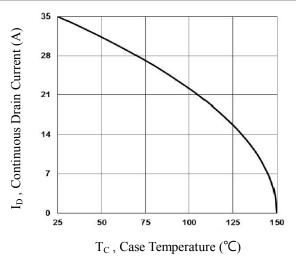
2. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%.

3. Essentially independent of operating temperature.

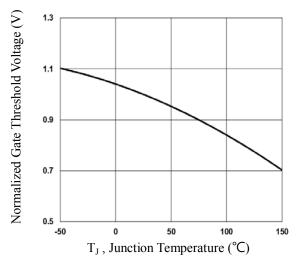


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#### **Characteristics Curves**









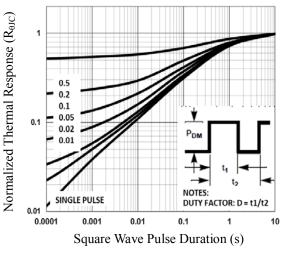


Fig.5 Normalized Transient Impedance

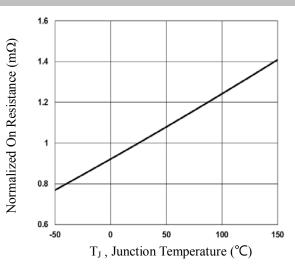


Fig.2 Normalized RDSON vs. T<sub>J</sub>

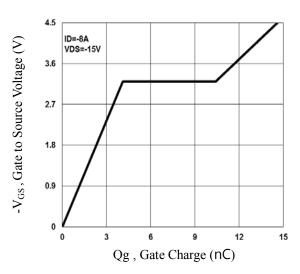


Fig.4 Gate Charge Waveform

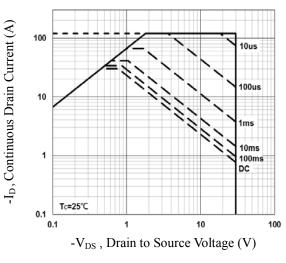


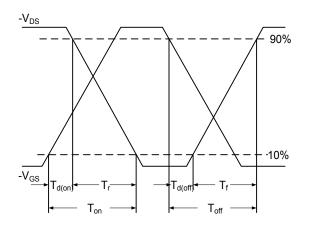
Fig.6 Maximum Safe Operation Area

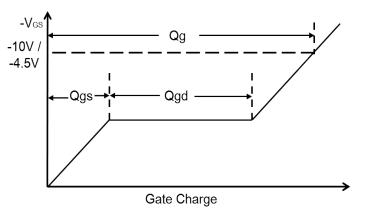


# Pho, RoHS

### **30V P-Channel MOSFETs**

#### **Characteristics Curves**





#### Fig.7 Switching Time Waveform



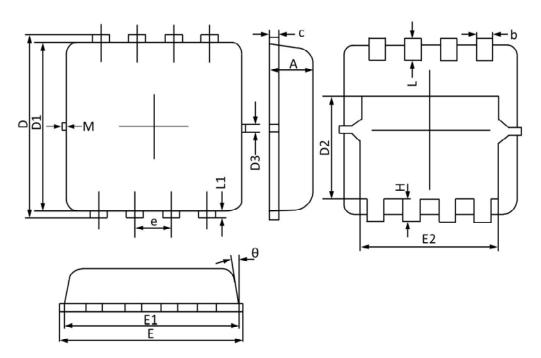


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### **30V P-Channel MOSFETs**

#### Package Outline Dimensions

PPAK3X3



Symbol	<b>Dimensions</b>	In Millimeters	Dimension	s In Inches	
Symbol	Min	Max	Min	Max	
Α	0.700	0.800	0.028	0.031	
b	0.250	0.350	0.010	0.013	
с	0.100	0.250	0.004	0.009	
D	3.250	3.450	0.128	0.135	
D1	3.000	3.200	0.119	0.125	
D2	1.780	1.980	0.070	0.077	
D3	0.13	) REF	0.005 REF		
E	3.200	3.400	0.126	0.133	
<b>E</b> 1	3.000	3.200	0.119	0.125	
E2	2.390	2.590	0.094	0.102	
e	0.65	0.650 BSC		BSC	
Н	0.300	0.500	0.011	0.019	
L	0.300	0.500	0.011	0.019	
L1	0.13	) REF	0.005	REF	
$\theta$	<b>0°</b>	12°	<b>0°</b>	12°	
Μ	0.15	) REF	0.006 REF		



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